

Notice of References Cited	Application/Control No. 10/560,073	Applicant(s)/Patent Under Reexamination MASUKO ET AL.	
	Examiner ANISH DESAI	Art Unit 1794	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-			
	B	US-			
	C	US-			
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FOREIGN PATENT DOCUMENTS

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NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Takashi Masuko, "Adhesive Film, Its Manufacturing Method, Support Component With Adhesive Film and Semiconductor Device", English translation of JP 11-140386, 05/25/1990.
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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.